



720p OLED microdisplay evaluation kit and driving electronics

Microdisplays are tiny displays providing very high resolutions at the same time. Typically they are based on CMOS backplane technology, which is able to provide the necessary pixel densities and circuitry performance. For more than 10 years, Fraunhofer IPMS has been developing specific display solutions, that are predestined for use in data glasses and head mounted displays (HMDs). The existing portfolio of Fraunhofer IPMS has now been complemented by a new generation of OLED microdisplays that are perfectly adapted to the requirements of industrial AR data glasses – the 0.64" 720p microdisplay, which features high frame rates, high contrast ratio and low power consumption.

Each display is application-specific, because parameters such as brightness, resolution, framerate, power consumption, screen size, contrast ratio, color and complexity of the electronics play a major role in the increasingly professional and demanding requirements. Based on the requirements, two separate display types can be considered in general:

Information displays and conventional video displays. Most industrial use cases require focused information rather than a running video stream. Furthermore other parameters play an important role such as ergonomics, compactness and a battery runtime of more than one shift for the complete system. Augmented Reality (AR) in industrial applications is often used for real-time overlay of design data or assistance scenarios.



Novel AR assistance system for industrial use



720p microdisplay with controller box (side view)

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The new 720p OLED microdisplay

1280 × 720 pixels plus additional 10

image adjustment, summing up in a

total resolution of 1300 × 740 pixels.

Based on a subpixel size of 5.5 μ m × 5.5 μ m and four sub-pixels, which are

configured in a RGBW setup for the

initial prototype, the nominal active

area of 14.1 mm × 7.92 mm results in a

screen diagonal of 0.64". Using a four

sub-pixel arrangement also enables a

with four times higher resolution, i.e. 2560×1440 pixels.The backplane

already provides all necessary driver circuitry to operate the displays from a

standard 24 Bit parallel RGB interface using well known synchronization signals

vertical synchronization (VS), horizontal

Evaluation kit HUCW1010

can be purchased for evaluation

purposes. Therefore we offer an

evaluation kit as follows:

Driving electronics HDMI and USB cable

Configuration GUI

Documentation

a rigid PCB

synchronization (HS) and data enable (DE).

The Fraunhofer IPMS OLED microdisplays

Full color display with 24 Bit color depth

(for Windows based systems only)

Packaged as COB (chip-on-board) on

monochrome version of that backplane

pixels in each direction for display

provides a nominal resolution of





Global emit

Technical data

Rolling emit

Key features of the driving circuitry Our offer

Gamma adjustment:

The gamma of the display can be adjusted individually for each of the four data pipelines related to each of the subpixels. This is realized by a chip internal resolution of 10 Bit and an 8 Bit/10 Bit mapping.

White calculation:

The value of the fourth (white) subpixel can be calculated inside the backplane based on the red, green and blue color values. It can also be provided externally, which enables a separate high-lighting data channel to provide additional information such as focus-peaking information in electronic viewfinders.

Emit mode:

To reduce perceived motion blur the timing of the light emission can be controlled. Typically two modes can be distinguished: hold mode and impulse mode (also called rolling emit). The latter can be controlled in a wide range.

Pixel current adjustment:

The pixel current and thus overall brightness can be controlled in a wide range to support different OLED stacks as well as to provide enough headroom for the backplane IC to drive impulse mode.

Typically the current density of the pixel is set to 20 mA/cm² ... 30 mA/cm². Subpixel currents up to 550 nA have been characterized, which corresponds to a current density of 1.8 A/cm². We are ready to provide customer-specific developments, prototyping and the manufacturing of small series.

Technical specifications

Parameter	Value
Nominal display res.	1280 × 720 (720p)
Total display res.	1300 × 740
Number of subpixels	3.85 million
Active area	14.1 mm × 7.92 mm
Chip size	16.9 mm × 10.4 mm
Display diagonal	0.64"
Framerate	60, 75, 90 and 120 Hz
Contrast ratio	> 100000:1
Uniformity	> 95%
Pixel setup	RGBW
Pixel pitch (RGBW)	11 μm × 11 μm
Pixel pitch (subpixel)	5.5 μm × 5.5 μm
Color depth	24 Bit
	(32 Bit incl. white)
Display interface	24 Bit RGB digital,
	parallel + synchroniz-
	ation signals CLK, VS,
	HS and DE
Display brightness	300 cd/m² (typ.)
Typ. power	100 mW@60 Hz
consumption	
Config. interface	TWI (two-wire-interface)
I/O voltage	3.3 V (1.6 V 5.5 V)
Core voltage	1.8 V (1.6 V 2.0 V)
Cathode voltage	-1 V6.5 V
	(depending on OLED)
Temperature range	-40°C +65°C

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